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UL recognition, file #E230084  
Low thermal resistance  
Glass passivated chip junction  
High surge current capability  
Solder dip 275 °C max. 7 s, per JESD 22-B106

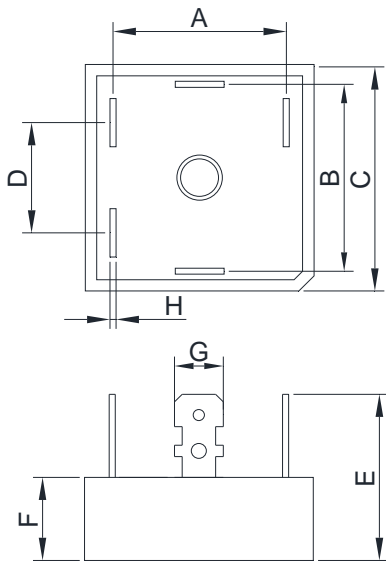
General purpose use in AC/DC bridge full wave rectification  
for

: SKBPC

Molding compound meets UL 94 V-0 flammability  
rating, RoHS-compliant

: Tin plated leads, solderable per  
J-STD-002 and JESD22-B102  
As marked on body





| A | 23.1 | 24.1 |
|---|------|------|
| B | 23.1 | 24.1 |
| C | 28.2 | 28.8 |
| D | 16.0 | 17.0 |
| E | /    | 25   |
| F | 10.8 | 11.2 |
| G | 6.2  | 6.4  |
| H | 0.75 | 0.85 |
| I | 4.5  | 5.5  |



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